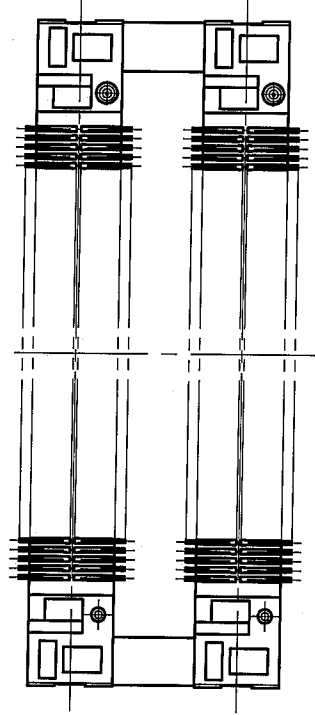
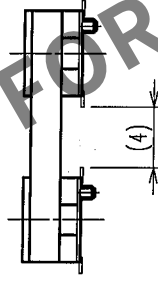
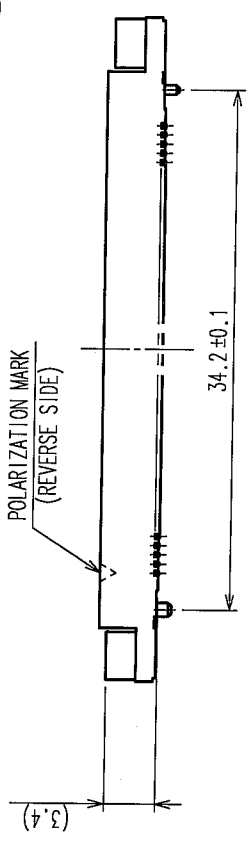
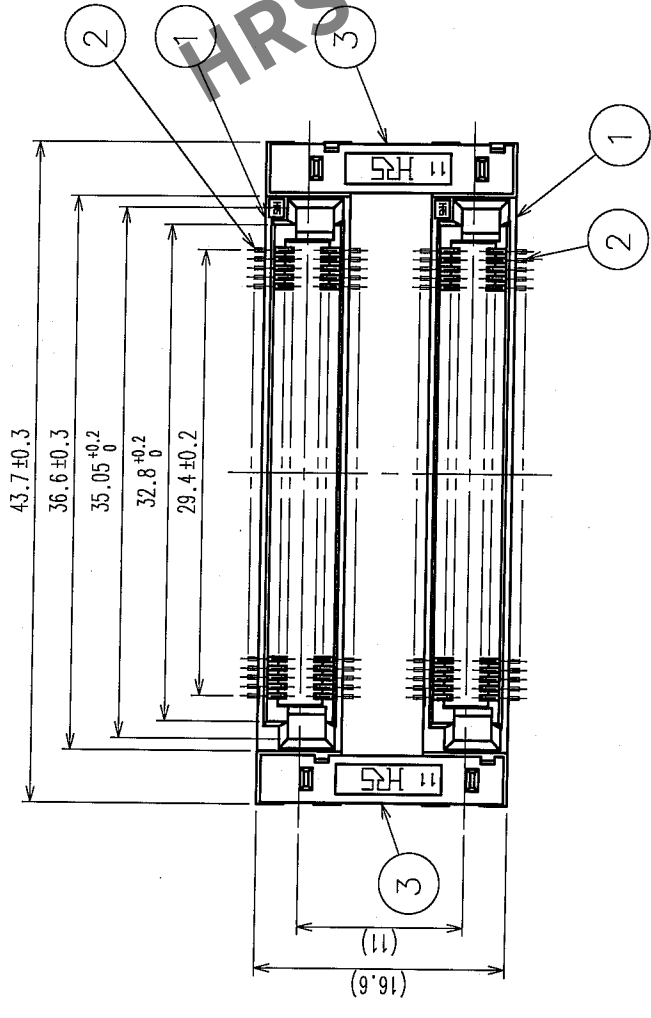
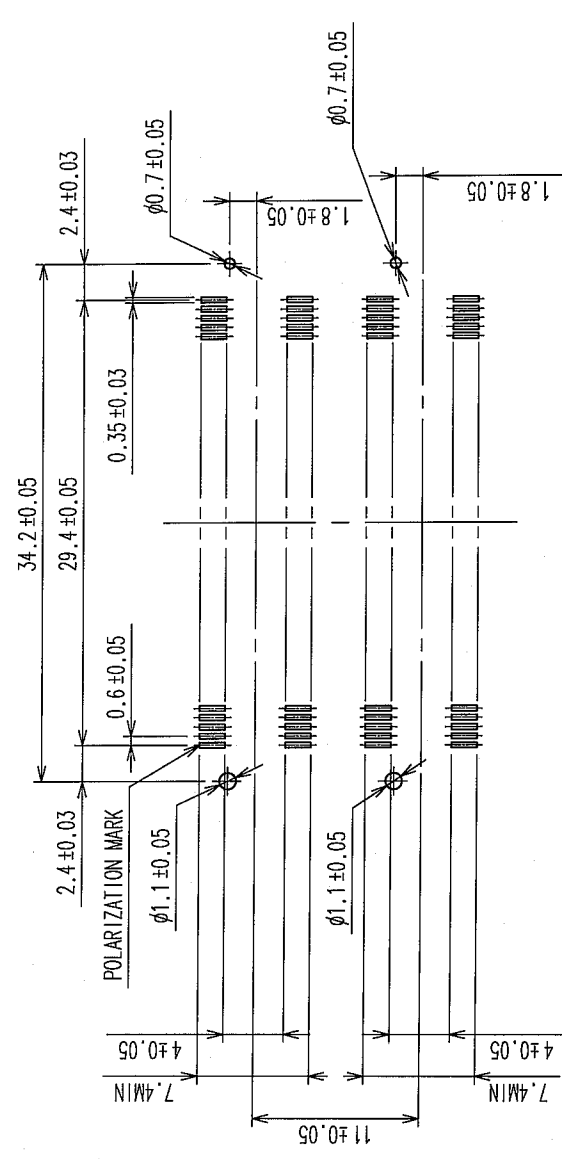


COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△				•	△				•
△				•	△				•
△				•	△				•



RECOMMENDED LAND PATTERN DIMENSION
OF PCB (MOUNTING SIDE)



- NOTES
- 1 LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 - 2 AFTER MOUNTING BOARD, REF.NO.3 SHALL BE REMOVED.
 - 3 FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED DEPENDS ON CIRCUMSTANCES.
 - 4 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

1, 3	PPS	LIGHT BROWN (UL94V-0)		2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μ m min LEAD AREA: GOLD FLASH UNDER PLATING: NICKEL 1.5μ m min	
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS	
CODE NO. (OLD)				DRAWN	DESIGNED	CHECKED	APPROVED
CL				S. KAMIGA	M. Nakamura	L. Ogawa	H. Okawa
				06.01.20	06.01.23	06.01.23	06.01.23
		DRAWING NO.		PART NO.			
SCALE		EDC3-150963-25		FX8C-100/100S11-SVJ (71)			
2 : 1							
UNITS		HIROSE ELECTRIC CO., LTD		CODE NO.		CL578-0905-8-71	
mm						1/2	

TO	PCK			
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